

# 74AUP1G14

## Low-power Schmitt trigger inverter

Rev. 03 — 8 July 2009

Product data sheet

### 1. General description

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The 74AUP1G14 provides a single inverting Schmitt trigger which accepts standard input signals. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

This device ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage  $V_{T+}$  and the negative voltage  $V_{T-}$  is defined as the input hysteresis voltage  $V_H$ .

### 2. Features

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- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
  - ◆ HBM JESD22-A114E Class 3A exceeds 5000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM JESD22-C101C exceeds 1000 V
- Low static power consumption;  $I_{CC} = 0.9 \mu A$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of  $V_{CC}$
- $I_{OFF}$  circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from  $-40^{\circ}C$  to  $+85^{\circ}C$  and  $-40^{\circ}C$  to  $+125^{\circ}C$

### 3. Applications

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- Wave and pulse shaper
- Astable multivibrator
- Monostable multivibrator

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G14GW	−40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AUP1G14GM	−40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1G14GF	−40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891

5. Marking

Table 2. Marking

Type number	Marking code <sup>[1]</sup>
74AUP1G14GW	pF
74AUP1G14GM	pF
74AUP1G14GF	pF

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram

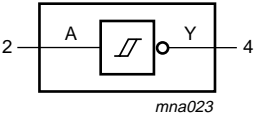


Fig 1. Logic symbol

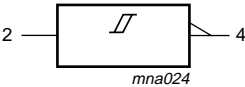


Fig 2. IEC logic symbol

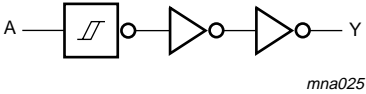
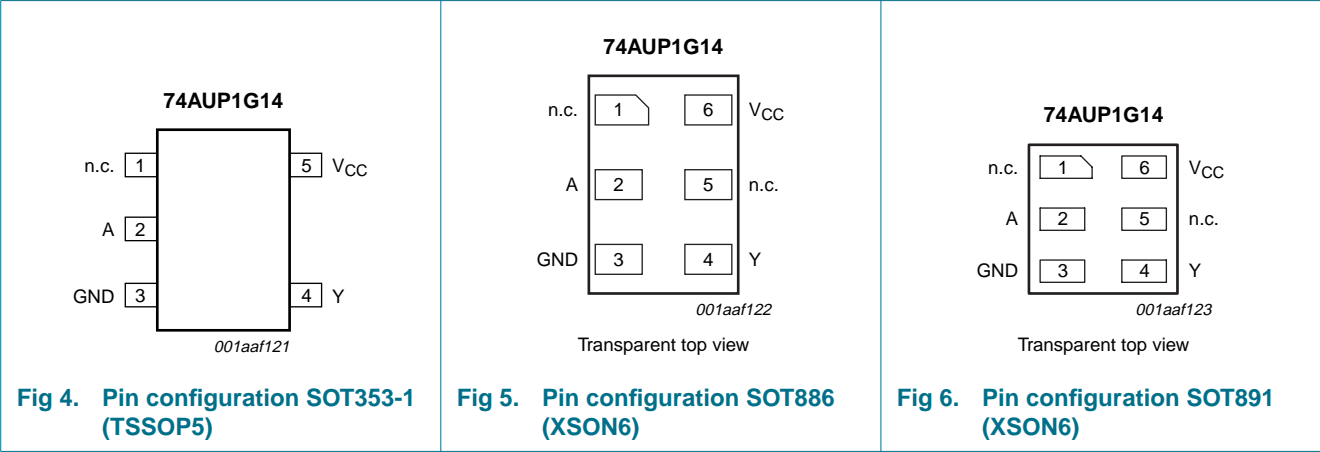


Fig 3. Logic diagram

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	TSSOP5	XSON6	
n.c.	1	1	not connected
A	2	2	data input
GND	3	3	ground (0 V)
Y	4	4	data output
n.c.	-	5	not connected
V <sub>CC</sub>	5	6	supply voltage

8. Functional description

Table 4. Function table<sup>[1]</sup>

Input	Output
A	Y
L	H
H	L

[1] H = HIGH voltage level;  
 L = LOW voltage level.

## 9. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
$I_{IK}$	input clamping current	$V_I < 0$ V	-50	-	mA
$V_I$	input voltage		[1] -0.5	+4.6	V
$I_{OK}$	output clamping current	$V_O < 0$ V	-50	-	mA
$V_O$	output voltage	Active mode and Power-down mode	[1] -0.5	+4.6	V
$I_O$	output current	$V_O = 0$ V to $V_{CC}$	-	$\pm 20$	mA
$I_{CC}$	supply current		-	+50	mA
$I_{GND}$	ground current		-50	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C	[2] -	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.

For XSON6 packages: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 10. Recommended operating conditions

**Table 6. Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		0.8	3.6	V
$V_I$	input voltage		0	3.6	V
$V_O$	output voltage	Active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0$ V	0	3.6	V
$T_{amb}$	ambient temperature		-40	+125	°C

## 11. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = 25$ °C						
$V_{OH}$	HIGH-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = -20$ $\mu$ A; $V_{CC} = 0.8$ V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_O = -1.1$ mA; $V_{CC} = 1.1$ V	$0.75 \times V_{CC}$	-	-	V
		$I_O = -1.7$ mA; $V_{CC} = 1.4$ V	1.11	-	-	V
		$I_O = -1.9$ mA; $V_{CC} = 1.65$ V	1.32	-	-	V
		$I_O = -2.3$ mA; $V_{CC} = 2.3$ V	2.05	-	-	V
		$I_O = -3.1$ mA; $V_{CC} = 2.3$ V	1.9	-	-	V
		$I_O = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V
		$I_O = -4.0$ mA; $V_{CC} = 3.0$ V	2.6	-	-	V

**Table 7.** Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{OL}$	LOW-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = 20\ \mu\text{A}$ ; $V_{CC} = 0.8\ \text{V}$ to $3.6\ \text{V}$	-	-	0.1	V
		$I_O = 1.1\ \text{mA}$ ; $V_{CC} = 1.1\ \text{V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7\ \text{mA}$ ; $V_{CC} = 1.4\ \text{V}$	-	-	0.31	V
		$I_O = 1.9\ \text{mA}$ ; $V_{CC} = 1.65\ \text{V}$	-	-	0.31	V
		$I_O = 2.3\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	-	-	0.31	V
		$I_O = 3.1\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	-	-	0.44	V
		$I_O = 2.7\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	-	-	0.31	V
		$I_O = 4.0\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	-	-	0.44	V
$I_I$	input leakage current	$V_I = \text{GND}$ to $3.6\ \text{V}$ ; $V_{CC} = 0\ \text{V}$ to $3.6\ \text{V}$	-	-	$\pm 0.1$	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 0\ \text{V}$ to $3.6\ \text{V}$ ; $V_{CC} = 0\ \text{V}$	-	-	$\pm 0.2$	$\mu\text{A}$
$\Delta I_{OFF}$	additional power-off leakage current	$V_I$ or $V_O = 0\ \text{V}$ to $3.6\ \text{V}$ ; $V_{CC} = 0\ \text{V}$ to $0.2\ \text{V}$	-	-	$\pm 0.2$	$\mu\text{A}$
$I_{CC}$	supply current	$V_I = \text{GND}$ or $V_{CC}$ ; $I_O = 0\ \text{A}$ ; $V_{CC} = 0.8\ \text{V}$ to $3.6\ \text{V}$	-	-	0.5	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	$V_I = V_{CC} - 0.6\ \text{V}$ ; $I_O = 0\ \text{A}$ ; $V_{CC} = 3.3\ \text{V}$	-	-	40	$\mu\text{A}$
$C_I$	input capacitance	$V_I = \text{GND}$ or $V_{CC}$ ; $V_{CC} = 0\ \text{V}$ to $3.6\ \text{V}$	-	1.1	-	pF
$C_O$	output capacitance	$V_O = \text{GND}$ ; $V_{CC} = 0\ \text{V}$	-	1.7	-	pF
<b><math>T_{amb} = -40\ ^\circ\text{C}</math> to <math>+85\ ^\circ\text{C}</math></b>						
$V_{OH}$	HIGH-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = -20\ \mu\text{A}$ ; $V_{CC} = 0.8\ \text{V}$ to $3.6\ \text{V}$	$V_{CC} - 0.1$	-	-	V
		$I_O = -1.1\ \text{mA}$ ; $V_{CC} = 1.1\ \text{V}$	$0.7 \times V_{CC}$	-	-	V
		$I_O = -1.7\ \text{mA}$ ; $V_{CC} = 1.4\ \text{V}$	1.03	-	-	V
		$I_O = -1.9\ \text{mA}$ ; $V_{CC} = 1.65\ \text{V}$	1.30	-	-	V
		$I_O = -2.3\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	1.97	-	-	V
		$I_O = -3.1\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	1.85	-	-	V
		$I_O = -2.7\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	2.67	-	-	V
		$I_O = -4.0\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	2.55	-	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = 20\ \mu\text{A}$ ; $V_{CC} = 0.8\ \text{V}$ to $3.6\ \text{V}$	-	-	0.1	V
		$I_O = 1.1\ \text{mA}$ ; $V_{CC} = 1.1\ \text{V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7\ \text{mA}$ ; $V_{CC} = 1.4\ \text{V}$	-	-	0.37	V
		$I_O = 1.9\ \text{mA}$ ; $V_{CC} = 1.65\ \text{V}$	-	-	0.35	V
		$I_O = 2.3\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	-	-	0.33	V
		$I_O = 3.1\ \text{mA}$ ; $V_{CC} = 2.3\ \text{V}$	-	-	0.45	V
		$I_O = 2.7\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	-	-	0.33	V
		$I_O = 4.0\ \text{mA}$ ; $V_{CC} = 3.0\ \text{V}$	-	-	0.45	V
$I_I$	input leakage current	$V_I = \text{GND}$ to $3.6\ \text{V}$ ; $V_{CC} = 0\ \text{V}$ to $3.6\ \text{V}$	-	-	$\pm 0.5$	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 0\ \text{V}$ to $3.6\ \text{V}$ ; $V_{CC} = 0\ \text{V}$	-	-	$\pm 0.5$	$\mu\text{A}$

**Table 7.** Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$\Delta I_{OFF}$	additional power-off leakage current	$V_I$ or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	$\pm 0.6$	$\mu$ A
$I_{CC}$	supply current	$V_I = \text{GND}$ or $V_{CC}$ ; $I_O = 0$ A; $V_{CC} = 0.8$ V to 3.6 V	-	-	0.9	$\mu$ A
$\Delta I_{CC}$	additional supply current	$V_I = V_{CC} - 0.6$ V; $I_O = 0$ A; $V_{CC} = 3.3$ V	-	-	50	$\mu$ A
<b><math>T_{amb} = -40</math> °C to <math>+125</math> °C</b>						
$V_{OH}$	HIGH-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = -20$ $\mu$ A; $V_{CC} = 0.8$ V to 3.6 V	$V_{CC} - 0.11$	-	-	V
		$I_O = -1.1$ mA; $V_{CC} = 1.1$ V	$0.6 \times V_{CC}$	-	-	V
		$I_O = -1.7$ mA; $V_{CC} = 1.4$ V	0.93	-	-	V
		$I_O = -1.9$ mA; $V_{CC} = 1.65$ V	1.17	-	-	V
		$I_O = -2.3$ mA; $V_{CC} = 2.3$ V	1.77	-	-	V
		$I_O = -3.1$ mA; $V_{CC} = 2.3$ V	1.67	-	-	V
		$I_O = -2.7$ mA; $V_{CC} = 3.0$ V	2.40	-	-	V
		$I_O = -4.0$ mA; $V_{CC} = 3.0$ V	2.30	-	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{T+}$ or $V_{T-}$				
		$I_O = 20$ $\mu$ A; $V_{CC} = 0.8$ V to 3.6 V	-	-	0.11	V
		$I_O = 1.1$ mA; $V_{CC} = 1.1$ V	-	-	$0.33 \times V_{CC}$	V
		$I_O = 1.7$ mA; $V_{CC} = 1.4$ V	-	-	0.41	V
		$I_O = 1.9$ mA; $V_{CC} = 1.65$ V	-	-	0.39	V
		$I_O = 2.3$ mA; $V_{CC} = 2.3$ V	-	-	0.36	V
		$I_O = 3.1$ mA; $V_{CC} = 2.3$ V	-	-	0.50	V
		$I_O = 2.7$ mA; $V_{CC} = 3.0$ V	-	-	0.36	V
		$I_O = 4.0$ mA; $V_{CC} = 3.0$ V	-	-	0.50	V
$I_I$	input leakage current	$V_I = \text{GND}$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	$\pm 0.75$	$\mu$ A
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	$\pm 0.75$	$\mu$ A
$\Delta I_{OFF}$	additional power-off leakage current	$V_I$ or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	$\pm 0.75$	$\mu$ A
$I_{CC}$	supply current	$V_I = \text{GND}$ or $V_{CC}$ ; $I_O = 0$ A; $V_{CC} = 0.8$ V to 3.6 V	-	-	1.4	$\mu$ A
$\Delta I_{CC}$	additional supply current	$V_I = V_{CC} - 0.6$ V; $I_O = 0$ A; $V_{CC} = 3.3$ V	-	-	75	$\mu$ A

## 12. Dynamic characteristics

**Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	25 °C			–40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
C <sub>L</sub> = 5 pF									
t <sub>pd</sub>	propagation delay	A to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	19.9	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.7	5.9	11.0	2.4	11.1	11.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.6	4.3	6.6	2.4	7.1	7.4	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.1	3.7	5.4	2.0	6.0	6.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.0	3.0	4.1	1.7	4.5	4.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.9	2.8	3.6	1.5	3.9	4.0	ns
C <sub>L</sub> = 10 pF									
t <sub>pd</sub>	propagation delay	A to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	23.4	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.9	6.8	12.7	2.8	12.8	12.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.8	5.0	7.7	2.6	8.2	8.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.7	4.2	6.2	2.5	6.7	7.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.3	3.6	4.8	2.1	5.2	5.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.1	3.3	4.3	2.0	4.5	4.7	ns
C <sub>L</sub> = 15 pF									
t <sub>pd</sub>	propagation delay	A to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	26.9	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.3	7.6	14.3	3.0	14.5	14.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.3	5.5	8.6	2.9	9.4	9.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.8	4.7	7.0	2.8	7.7	8.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.7	4.0	5.5	2.4	5.9	6.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.6	3.8	4.8	2.2	5.2	5.4	ns
C <sub>L</sub> = 30 pF									
t <sub>pd</sub>	propagation delay	A to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	37.3	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.0	9.8	18.7	3.9	19.6	20.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.7	7.1	11.2	3.8	12.3	12.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.6	6.0	9.1	3.6	10.0	10.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.5	5.2	6.9	3.2	7.5	7.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.3	4.8	6.1	3.1	7.1	7.4	ns

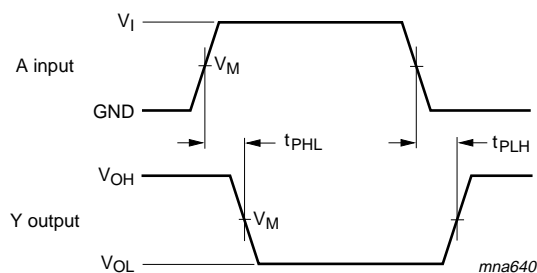
**Table 8. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	25 °C			–40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
C <sub>L</sub> = 5 pF, 10 pF, 15 pF and 30 pF									
C <sub>PD</sub>	power dissipation capacitance	f <sub>i</sub> = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub>	<sup>[3]</sup>						
		V <sub>CC</sub> = 0.8 V	-	2.6	-	-	-	-	pF
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	2.7	-	-	-	-	pF
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	2.9	-	-	-	-	pF
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	3.1	-	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	3.7	-	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	4.3	-	-	-	-	pF

- [1] All typical values are measured at nominal  $V_{CC}$ .
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).
- $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:
- $f_i$  = input frequency in MHz;
- $f_o$  = output frequency in MHz;
- $C_L$  = output load capacitance in pF;
- $V_{CC}$  = supply voltage in V;
- $N$  = number of inputs switching;
- $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## 13. Waveforms



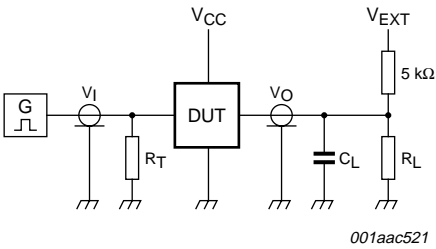
Measurement points are given in [Table 9](#).

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. The data input (A) to output (Y) propagation delays****Table 9. Measurement points**

Supply voltage	Output	Input		
$V_{CC}$	$V_M$	$V_M$	$V_I$	$t_r = t_f$
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{CC}$	$\leq 3.0 \text{ ns}$





Test data is given in [Table 10](#).  
Definitions for test circuit:  
 $R_L$  = Load resistance.  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig 8. Load circuitry for switching times

Table 10. Test data

Supply voltage	Load		$V_{EXT}$		
$V_{CC}$	$C_L$	$R_L$ [1]	$t_{PLH}$ , $t_{PHL}$	$t_{PZH}$ , $t_{PHZ}$	$t_{PZL}$ , $t_{PLZ}$
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times  $R_L = 5\text{ k}\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L = 1\text{ M}\Omega$ .

14. Transfer characteristics

Table 11. Transfer characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = 25\text{ }^{\circ}\text{C}$						
$V_{T+}$	positive-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.30	-	0.60	V
		$V_{CC} = 1.1\text{ V}$	0.53	-	0.90	V
		$V_{CC} = 1.4\text{ V}$	0.74	-	1.11	V
		$V_{CC} = 1.65\text{ V}$	0.91	-	1.29	V
		$V_{CC} = 2.3\text{ V}$	1.37	-	1.77	V
		$V_{CC} = 3.0\text{ V}$	1.88	-	2.29	V
$V_{T-}$	negative-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.10	-	0.60	V
		$V_{CC} = 1.1\text{ V}$	0.26	-	0.65	V
		$V_{CC} = 1.4\text{ V}$	0.39	-	0.75	V
		$V_{CC} = 1.65\text{ V}$	0.47	-	0.84	V
		$V_{CC} = 2.3\text{ V}$	0.69	-	1.04	V
		$V_{CC} = 3.0\text{ V}$	0.88	-	1.24	V

**Table 11. Transfer characteristics ...continued**

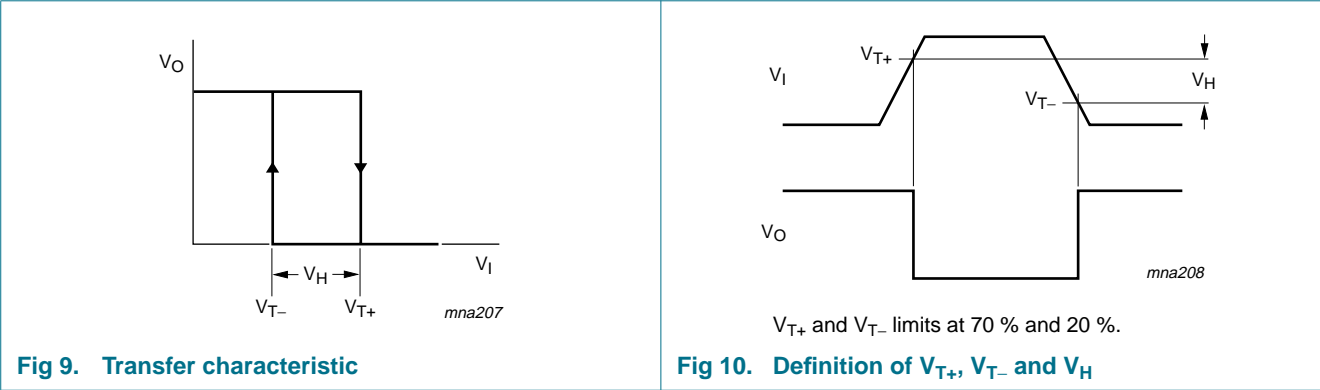
Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_H$	hysteresis voltage ( $V_{T+} - V_{T-}$ )	see <a href="#">Figure 9</a> , <a href="#">Figure 10</a> , <a href="#">Figure 11</a> and <a href="#">Figure 12</a>				
		$V_{CC} = 0.8\text{ V}$	0.07	-	0.50	V
		$V_{CC} = 1.1\text{ V}$	0.08	-	0.46	V
		$V_{CC} = 1.4\text{ V}$	0.18	-	0.56	V
		$V_{CC} = 1.65\text{ V}$	0.27	-	0.66	V
		$V_{CC} = 2.3\text{ V}$	0.53	-	0.92	V
		$V_{CC} = 3.0\text{ V}$	0.79	-	1.31	V
<b><math>T_{amb} = -40\text{ °C to }+85\text{ °C}</math></b>						
$V_{T+}$	positive-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.30	-	0.60	V
		$V_{CC} = 1.1\text{ V}$	0.53	-	0.90	V
		$V_{CC} = 1.4\text{ V}$	0.74	-	1.11	V
		$V_{CC} = 1.65\text{ V}$	0.91	-	1.29	V
		$V_{CC} = 2.3\text{ V}$	1.37	-	1.77	V
		$V_{CC} = 3.0\text{ V}$	1.88	-	2.29	V
$V_{T-}$	negative-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.10	-	0.60	V
		$V_{CC} = 1.1\text{ V}$	0.26	-	0.65	V
		$V_{CC} = 1.4\text{ V}$	0.39	-	0.75	V
		$V_{CC} = 1.65\text{ V}$	0.47	-	0.84	V
		$V_{CC} = 2.3\text{ V}$	0.69	-	1.04	V
		$V_{CC} = 3.0\text{ V}$	0.88	-	1.24	V
$V_H$	hysteresis voltage ( $V_{T+} - V_{T-}$ )	see <a href="#">Figure 9</a> , <a href="#">Figure 10</a> , <a href="#">Figure 11</a> and <a href="#">Figure 12</a>				
		$V_{CC} = 0.8\text{ V}$	0.07	-	0.50	V
		$V_{CC} = 1.1\text{ V}$	0.08	-	0.46	V
		$V_{CC} = 1.4\text{ V}$	0.18	-	0.56	V
		$V_{CC} = 1.65\text{ V}$	0.27	-	0.66	V
		$V_{CC} = 2.3\text{ V}$	0.53	-	0.92	V
		$V_{CC} = 3.0\text{ V}$	0.79	-	1.31	V
<b><math>T_{amb} = -40\text{ °C to }+125\text{ °C}</math></b>						
$V_{T+}$	positive-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.30	-	0.62	V
		$V_{CC} = 1.1\text{ V}$	0.53	-	0.92	V
		$V_{CC} = 1.4\text{ V}$	0.74	-	1.13	V
		$V_{CC} = 1.65\text{ V}$	0.91	-	1.31	V
		$V_{CC} = 2.3\text{ V}$	1.37	-	1.80	V
		$V_{CC} = 3.0\text{ V}$	1.88	-	2.32	V

**Table 11. Transfer characteristics ...continued**  
Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{T-}$	negative-going threshold voltage	see <a href="#">Figure 9</a> and <a href="#">Figure 10</a>				
		$V_{CC} = 0.8\text{ V}$	0.10	-	0.60	V
		$V_{CC} = 1.1\text{ V}$	0.26	-	0.65	V
		$V_{CC} = 1.4\text{ V}$	0.39	-	0.75	V
		$V_{CC} = 1.65\text{ V}$	0.47	-	0.84	V
		$V_{CC} = 2.3\text{ V}$	0.69	-	1.04	V
		$V_{CC} = 3.0\text{ V}$	0.88	-	1.24	V
$V_H$	hysteresis voltage ( $V_{T+} - V_{T-}$ )	see <a href="#">Figure 9</a> , <a href="#">Figure 10</a> , <a href="#">Figure 11</a> and <a href="#">Figure 12</a>				
		$V_{CC} = 0.8\text{ V}$	0.07	-	0.50	V
		$V_{CC} = 1.1\text{ V}$	0.08	-	0.46	V
		$V_{CC} = 1.4\text{ V}$	0.18	-	0.56	V
		$V_{CC} = 1.65\text{ V}$	0.27	-	0.66	V
		$V_{CC} = 2.3\text{ V}$	0.53	-	0.92	V
		$V_{CC} = 3.0\text{ V}$	0.79	-	1.31	V

15. Waveforms transfer characteristics



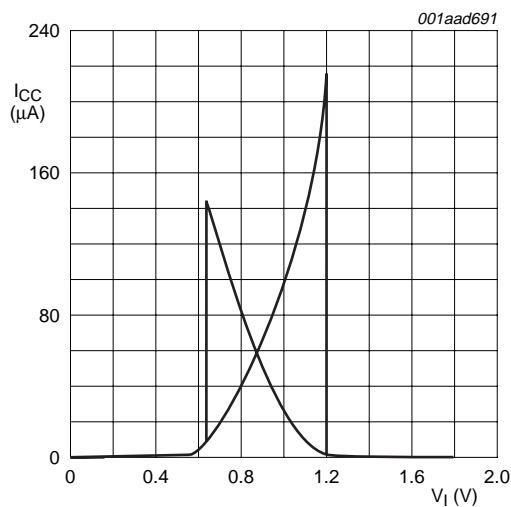


Fig 11. Typical transfer characteristics;  $V_{CC} = 1.8 \text{ V}$

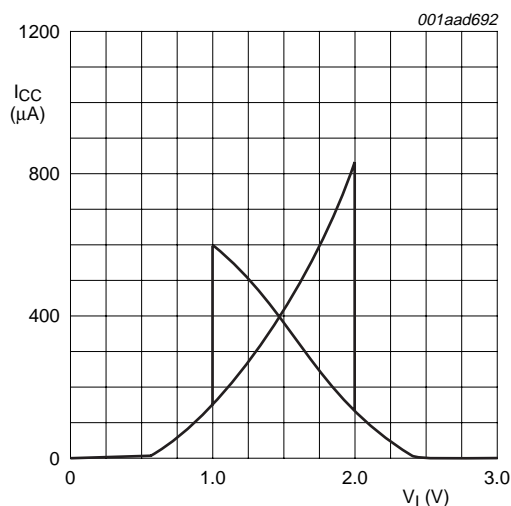


Fig 12. Typical transfer characteristics;  $V_{CC} = 3.0 \text{ V}$

## 16. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$P_{ad} = f_i \times (t_r \times I_{CC(AV)} + t_f \times I_{CC(AV)}) \times V_{CC}$  where:

$P_{ad}$  = additional power dissipation ( $\mu\text{W}$ );

$f_i$  = input frequency (MHz);

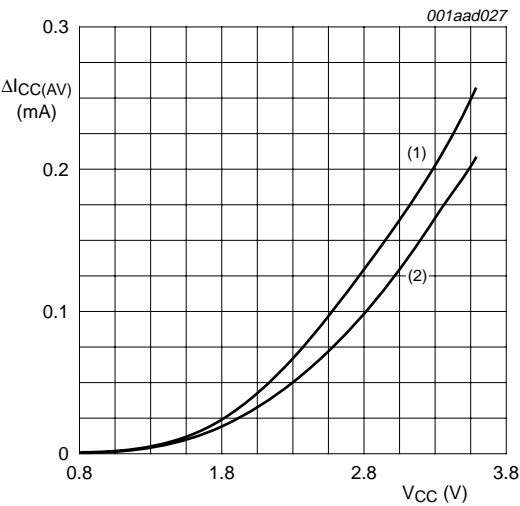
$t_r$  = input rise time (ns); 10 % to 90 %;

$t_f$  = input fall time (ns); 90 % to 10 %;

$I_{CC(AV)}$  = average additional supply current ( $\mu\text{A}$ ).

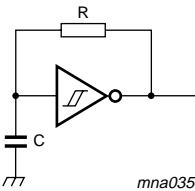
Average  $I_{CC}$  differs with positive or negative input transitions, as shown in [Figure 13](#).

An example of a relaxation circuit using the 74AUP1G14 is shown in [Figure 14](#).



- (1) Positive-going edge
- (2) Negative-going edge.

Fig 13. Average  $I_{CC}$  as a function of  $V_{CC}$



$$f = \frac{1}{T} \approx \frac{1}{a \times RC}$$

Average values for variable a are given in [Table 12](#).

Fig 14. Relaxation oscillator

Table 12. Variable values

Supply voltage	Variable a
1.1 V	1.28
1.5 V	1.22
1.8 V	1.24
2.8 V	1.34
3.3 V	1.45

17. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mmSOT353-1

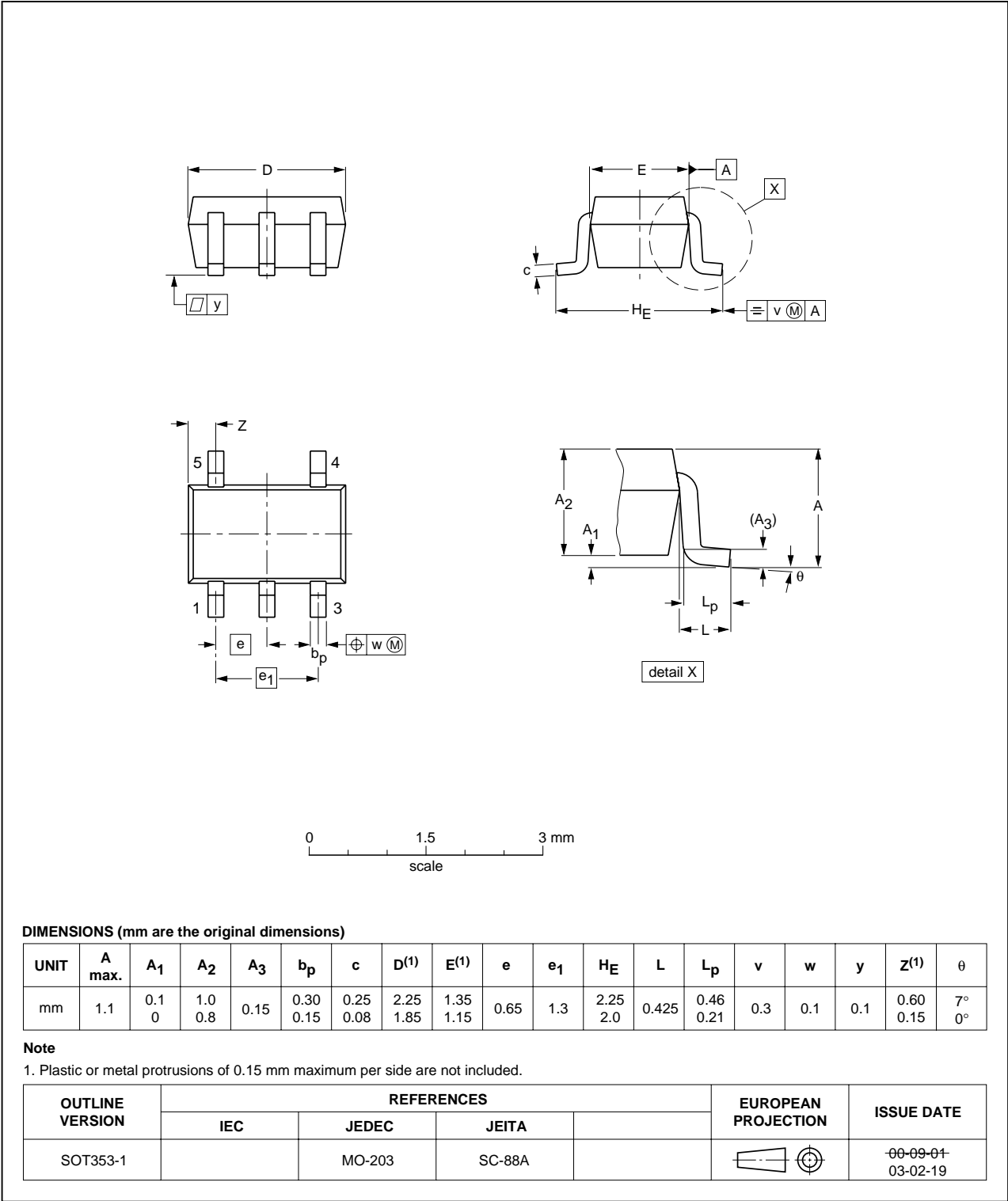


Fig 15. Package outline SOT353-1 (TSSOP5)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

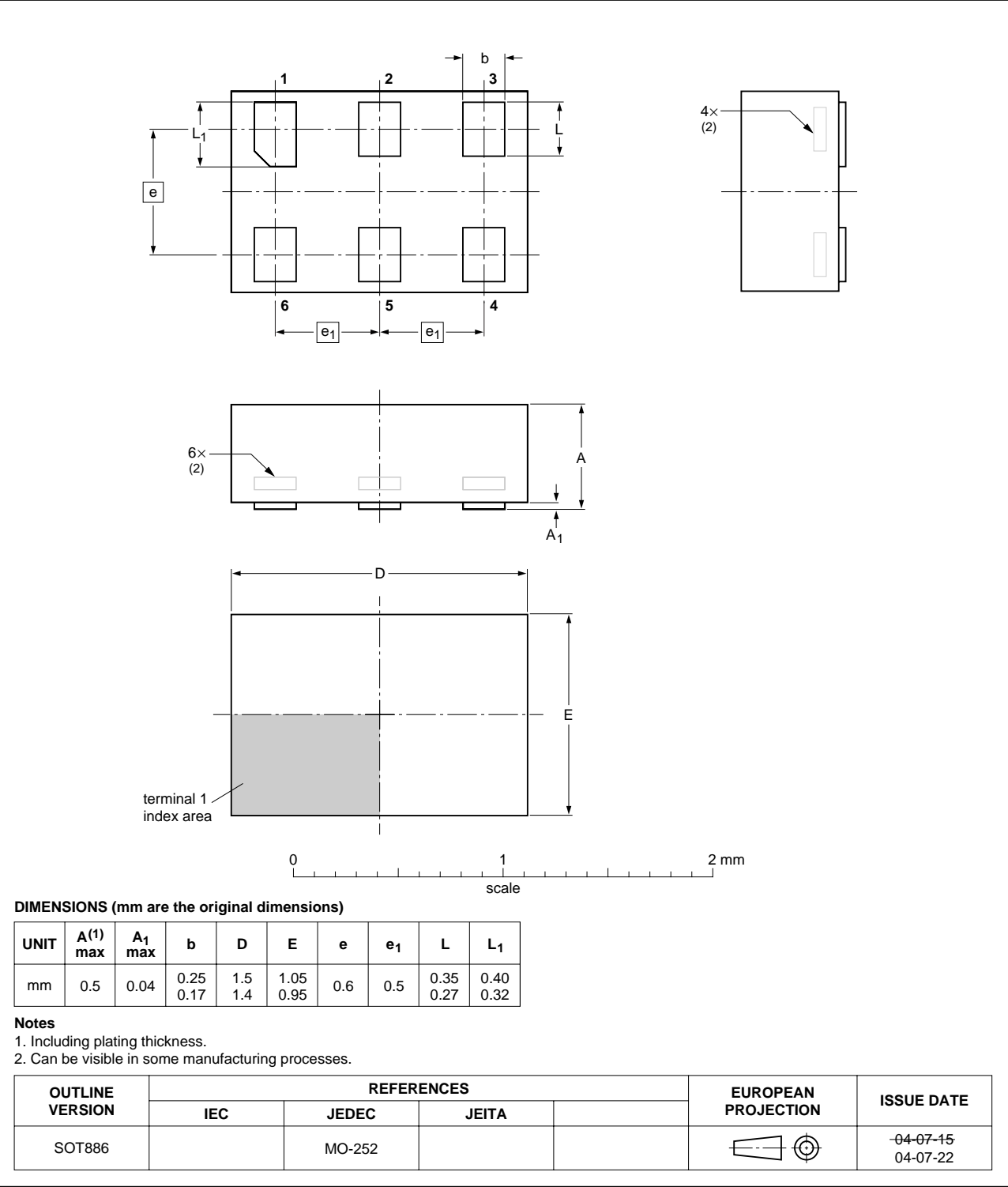


Fig 16. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

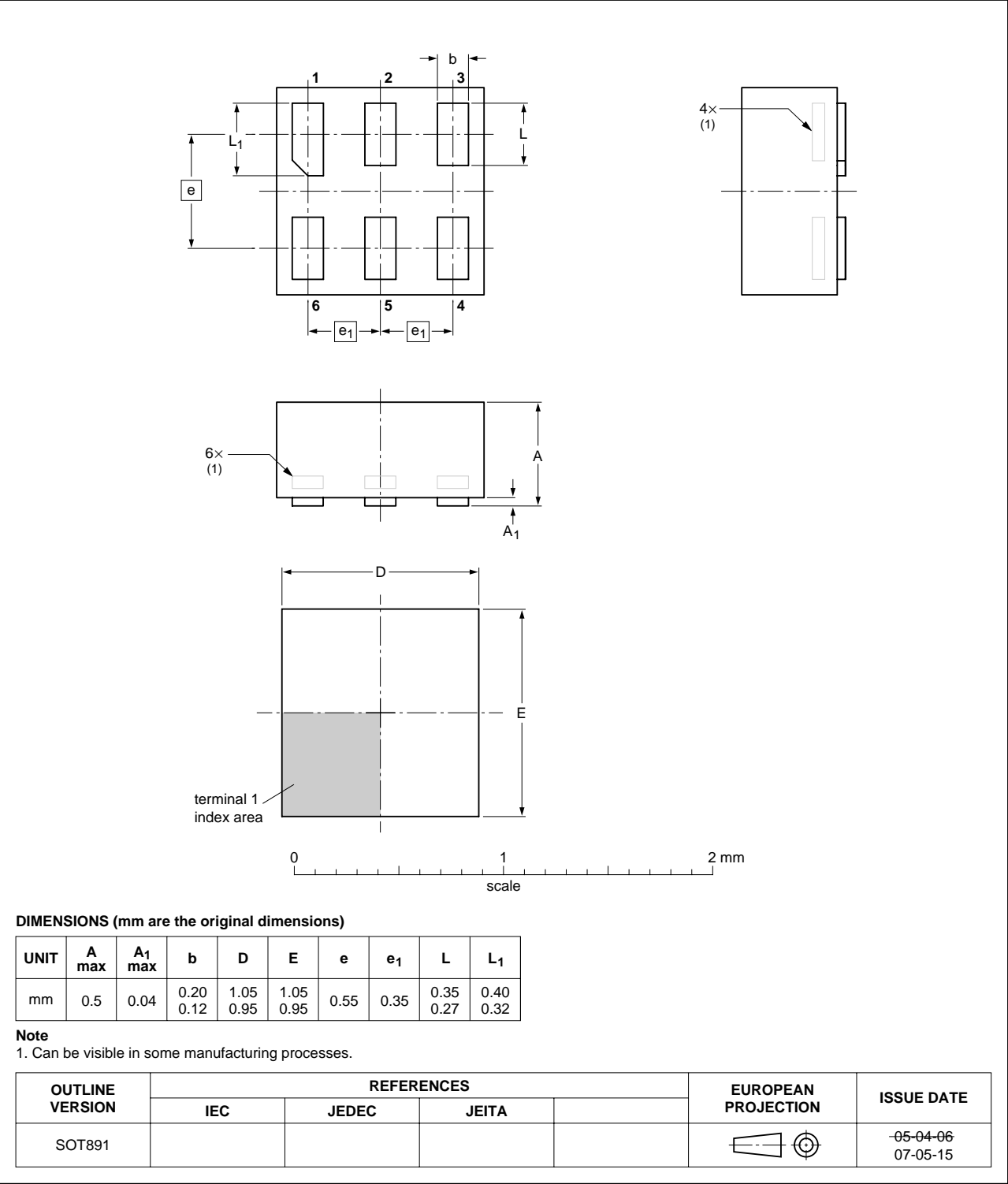


Fig 17. Package outline SOT891 (XSON6)



## 18. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 19. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G14_3	20090708	Product data sheet	-	74AUP1G14_2
Modifications:	<ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li><li>• Legal texts have been adapted to the new company name where appropriate.</li><li>• <a href="#">Section 9 "Limiting values"</a>: Changed: Derating factor of XSON6 packages.</li><li>• <a href="#">Section 11 "Static characteristics"</a>: Changed: conditions for HIGH-level output voltage and LOW-level output voltage.</li></ul>			
74AUP1G14_2	20060828	Product data sheet	-	74AUP1G14_1
74AUP1G14_1	20050718	Product data sheet	-	-

## 20. Legal information

### 20.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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